

# **Absolute Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	VcBO	-50	V
Collector-Emitter Voltage	Vceo	-50	V
Emitter-Base Voltage	VEBO	-5	V
Collector Current - Continuous	Ic	-100	mA
Peak Pulse Collector Current	Ісм	-200	mA
Base Current	lв	-30	mA

### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 6)	D-	400	mW	
Power Dissipation	(Note 7)	P <sub>D</sub>	1000		
Thermal Resistance, Junction to Ambient	(Note 6)		310	°C/W	
	(Note 7)	$R_{ hetaJA}$	120	C/VV	
Thermal Resistance, Junction to Lead	(Note 8)	R <sub>0</sub> JL	120	°C/W	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

# ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

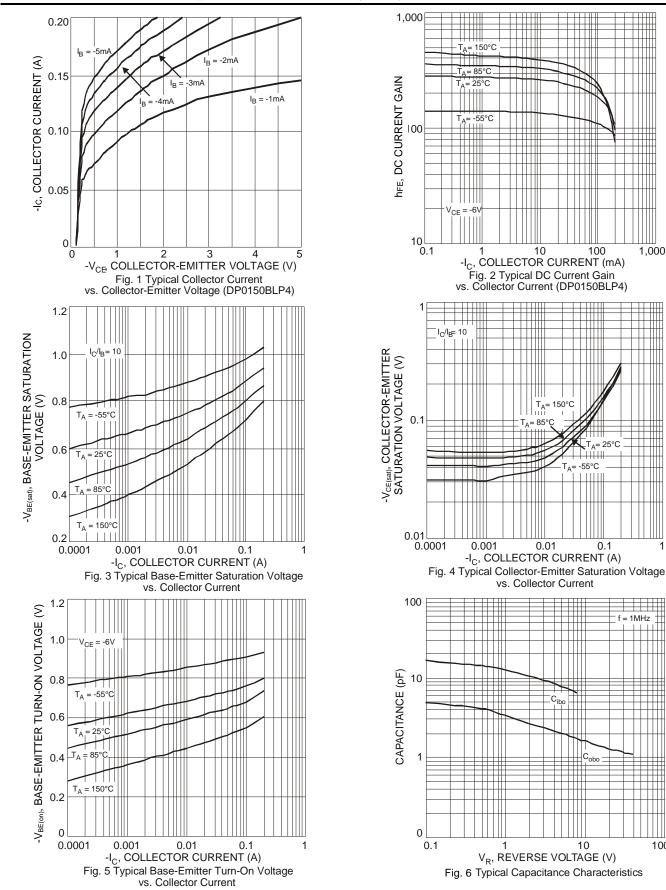
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS							
Collector-Base Breakdown Voltage		BV <sub>CBO</sub>	-50	_	_	V	$I_C = -10\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 9)		BVceo	-50	_	_	V	$I_C = -1 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage		BVEBO	-5	_	_	V	$I_E = -10\mu A, I_C = 0$
Collector Cut-Off Current		I <sub>CBO</sub>	_	_	-0.1	μΑ	$V_{CB} = -50V, I_{E} = 0$
Emitter Cut-Off Current		ІЕВО	_	_	-0.1	μΑ	$V_{EB} = -5V, I_{C} = 0$
ON CHARACTERISTICS (Note 10)							
Collector-Emitter Saturation Voltage		VCE(sat)	_	-0.15	-0.3	V	$I_C = -100 \text{mA}, I_B = -10 \text{mA}$
DC Current Gain DP0150ALP4	hee	120	_	240		VcF = -6V. Ic = -2mA	
	DP0150BLP4	h <sub>FE</sub>	200	_	400		VCE = -0V, IC = -2IIIA
SMALL SIGNAL CHARACTERISTICS							
Transition Frequency		f⊤	80	_	_	MHz	VcE = -10V, IE = -1mA f = 30MHz
Output Capacitance		C <sub>obo</sub>	_	1.6	_	pF	V <sub>CB</sub> = -10V, I <sub>E</sub> = 0, f = 1MHz

Notes:

- 6. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.
- 7. Same as Note 6, except the exposed collector pad is mounted on 25mm x 25mm 2oz copper.
- 8. Thermal resistance from junction to solder-point (on the exposed collector pad).
- 9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.
- 10. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.



### Electrical Characteristics (@TA = +25°C, unless otherwise specified.)



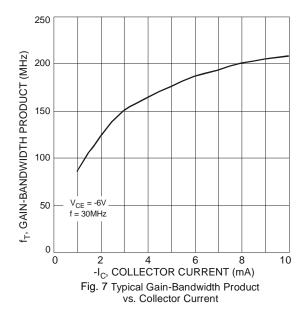
100

f = 1MHz

1,000





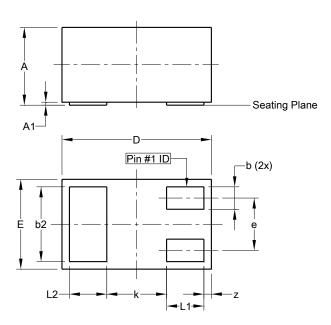




### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### X2-DFN1006-3

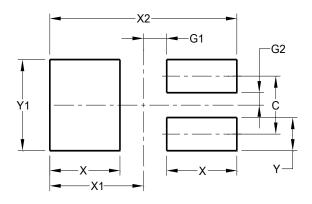


X2-DFN1006-3					
Dim	Min	Max	Тур		
Α	_	0.40	_		
A1	0.00	0.05	0.03		
b	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.05	1.00		
Е	0.55	0.65	0.60		
е			0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
k			0.40		
Z	0.02	0.08	0.05		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-DFN1006-3



Dimensions	Value (in mm)
С	0.350
G1	0.150
G2	0.075
Х	0.450
X1	0.600
X2	1.200
Y	0.200
Y1	0.550



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